

# International **IR** Rectifier

## IRLI3803PbF

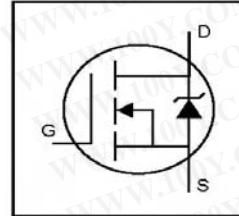
HEXFET® Power MOSFET

- Logic-Level Gate Drive
- Advanced Process Technology
- Ultra Low On-Resistance
- Isolated Package
- High Voltage Isolation = 2.5KVRMS ⑤
- Sink to Lead Creepage Dist. = 4.8mm
- Fully Avalanche Rated
- Lead-Free

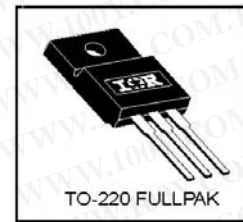
### Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 Fullpak eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The Fullpak is mounted to a heatsink using a single clip or by a single screw fixing.



$V_{DS} = 30V$
$R_{DS(on)} = 0.006\Omega$
$I_D = 76A$



### Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 5.0V$	76	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 5.0V$	54	
$I_{DM}$	Pulsed Drain Current ①②	470	
$P_D @ T_C = 25^\circ C$	Power Dissipation	63	W
	Linear Derating Factor	0.42	W/°C
$V_{GS}$	Gate-to-Source Voltage	±16	V
$E_{AS}$	Single Pulse Avalanche Energy ②③	610	mJ
$I_{AR}$	Avalanche Current ①③	71	A
$E_{AR}$	Repetitive Avalanche Energy ①	6.3	mJ
dv/dt	Peak Diode Recovery dv/dt ③④	5.0	V/ns
$T_J$	Operating Junction and	-55 to +175	°C
$T_{STG}$	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

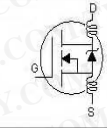
### Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	---	---	2.4	°C/W
$R_{\theta JA}$	Junction-to-Ambient	---	---	65	

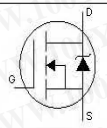
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## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

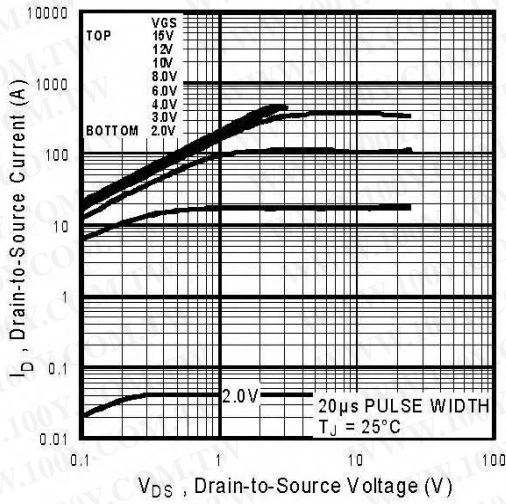
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.052	—	V/°C	Reference to $25^\circ\text{C}, I_D = 1mA$ Ⓓ
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	0.006	$\Omega$	$V_{GS} = 10V, I_D = 40A$ Ⓓ
		—	—	0.009		$V_{GS} = 4.5V, I_D = 34A$ Ⓓ
$V_{GS(th)}$	Gate Threshold Voltage	1.0	—	—	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
$g_{fs}$	Forward Transconductance	55	—	—	S	$V_{DS} = 25V, I_D = 71A$ Ⓓ
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	25	$\mu A$	$V_{DS} = 30V, V_{GS} = 0V$
		—	—	250		$V_{DS} = 24V, V_{GS} = 0V, T_J = 150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS} = 16V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -16V$
$Q_g$	Total Gate Charge	—	—	140	nC	$I_D = 71A$
$Q_{gs}$	Gate-to-Source Charge	—	—	41		$V_{DS} = 24V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	—	78		$V_{GS} = 4.5V$ , See Fig. 6 and 13 ⒹⒺ
$t_{d(on)}$	Turn-On Delay Time	—	14	—	ns	$V_{DD} = 15V$
$t_r$	Rise Time	—	230	—		$I_D = 71A$
$t_{d(off)}$	Turn-Off Delay Time	—	29	—		$R_G = 1.3\Omega, V_{GS} = 4.5V$
$t_f$	Fall Time	—	35	—		$R_D = 0.20\Omega$ , See Fig. 10 ⒹⒺ
$L_D$	Internal Drain Inductance	—	4.5	—	nH	Between lead, 6mm (0.25in.) from package and center of die contact
$L_S$	Internal Source Inductance	—	7.5	—		
$C_{iss}$	Input Capacitance	—	5000	—	pF	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	1800	—		$V_{DS} = 25V$
$C_{rss}$	Reverse Transfer Capacitance	—	880	—		$f = 1.0MHz$ , See Fig. 5Ⓓ
C	Drain to Sink Capacitance	—	12	—		$f = 1.0MHz$

## Source-Drain Ratings and Characteristics

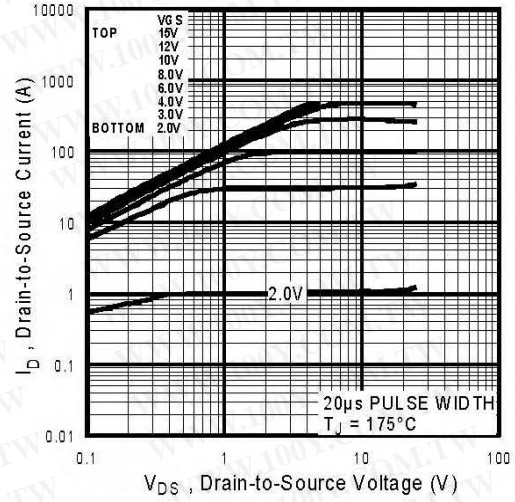
	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	76	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ⒹⒺ	—	—	470		
$V_{SD}$	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}, I_S = 40A, V_{GS} = 0V$ Ⓓ
$t_{rr}$	Reverse Recovery Time	—	120	180	ns	$T_J = 25^\circ\text{C}, I_F = 71A$
$Q_{rr}$	Reverse Recovery Charge	—	450	680	nC	$di/dt = 100A/\mu s$ ⒹⒺ

### Notes:

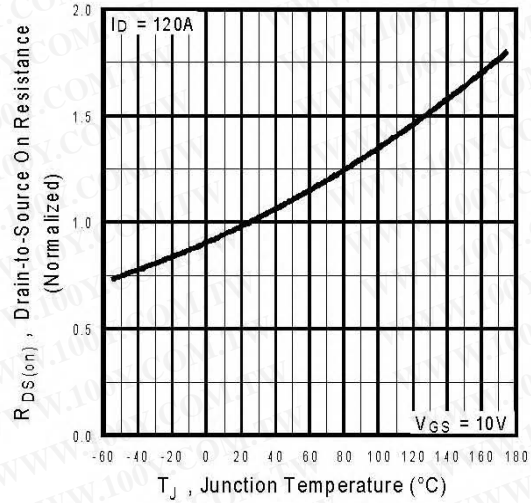
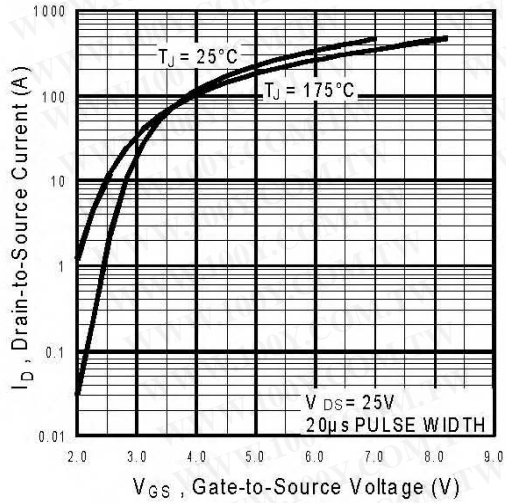
- Ⓓ Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )  
 Ⓔ  $I_{SD} \leq 71A, di/dt \leq 130A/\mu s, V_{DD} \leq V_{(BR)DSS}, t = 60s, f = 60Hz, T_J \leq 175^\circ\text{C}$   
 Ⓕ  $V_{DD} = 15V, \text{ starting } T_J = 25^\circ\text{C}, L = 180\mu H, R_G = 25\Omega, I_{AS} = 71A. (See Figure 12)$   
 Ⓖ Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .  
 Ⓗ Uses IRL3803 data and test conditions



**Fig 1.** Typical Output Characteristics



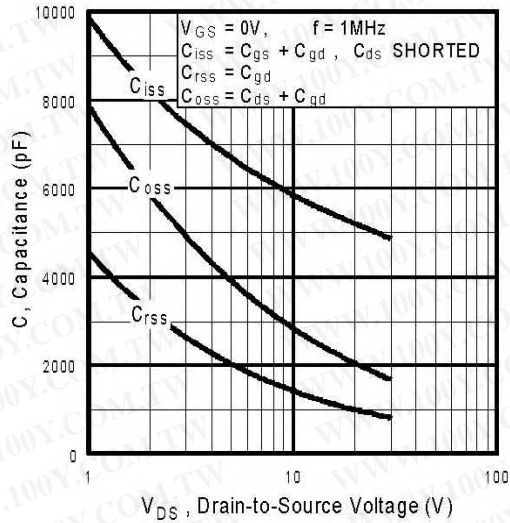
**Fig 2.** Typical Output Characteristics



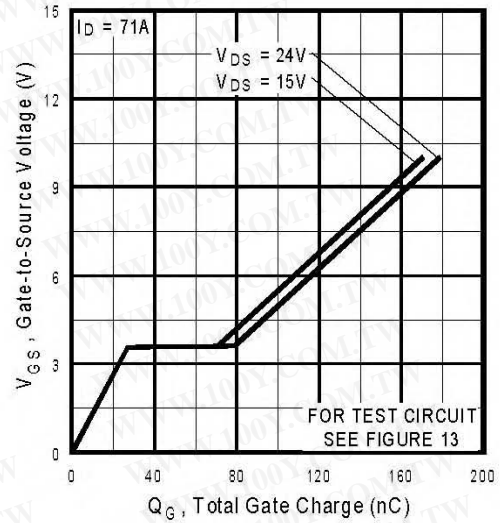
**Fig 4.** Normalized On-Resistance Vs. Temperature

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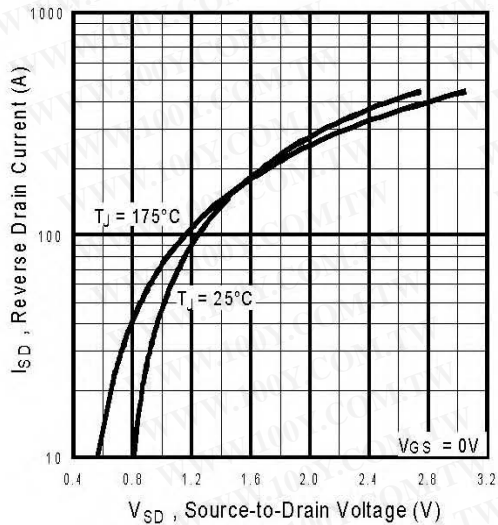
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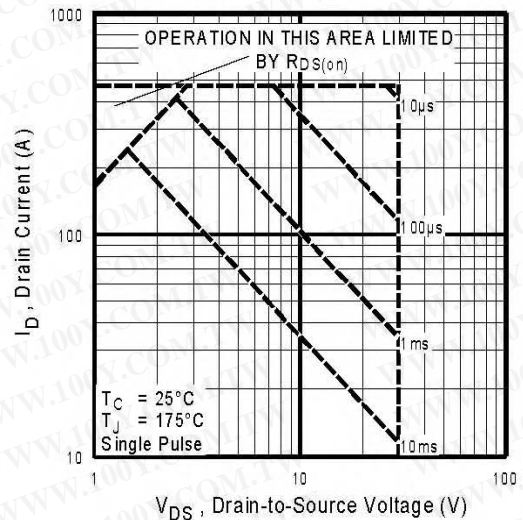
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



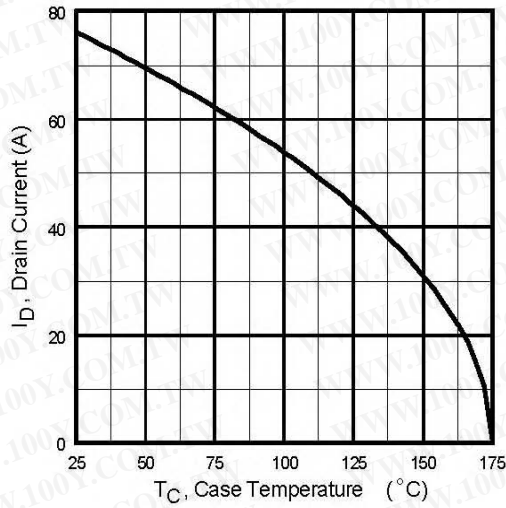
**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



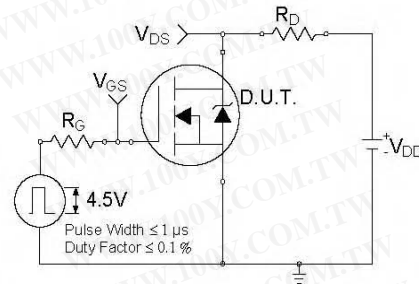
**Fig 7.** Typical Source-Drain Diode Forward Voltage



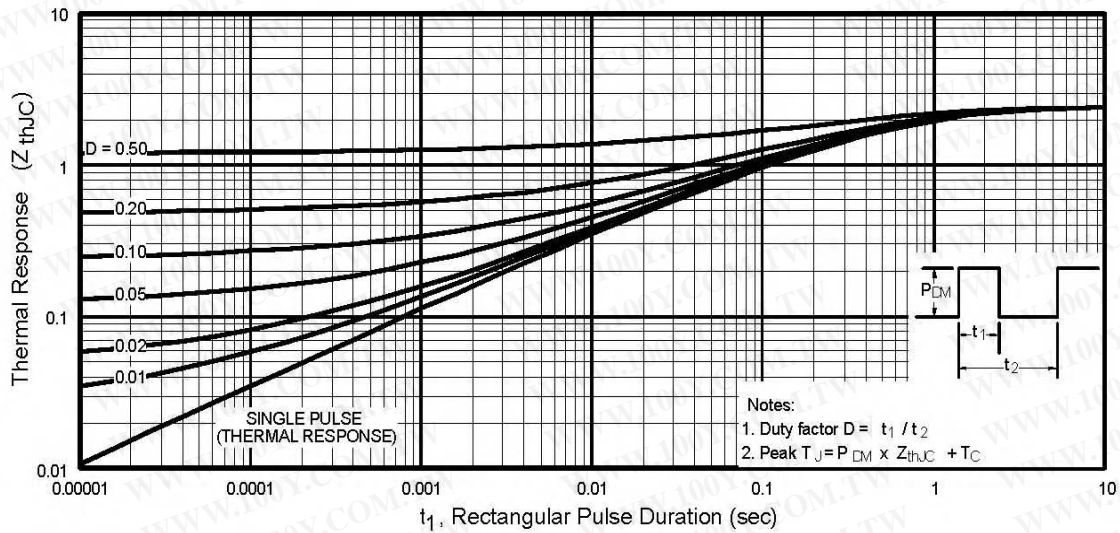
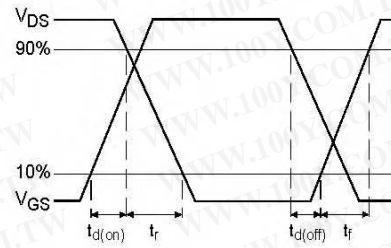
**Fig 8.** Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature



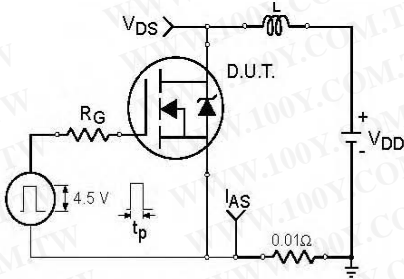
**Fig 10a.** Switching Time Test Circuit



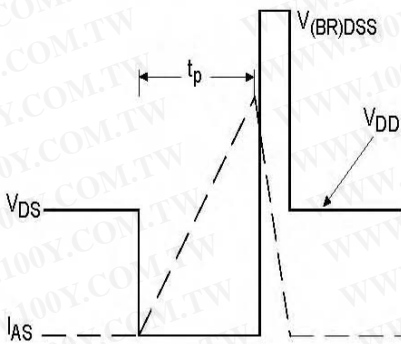
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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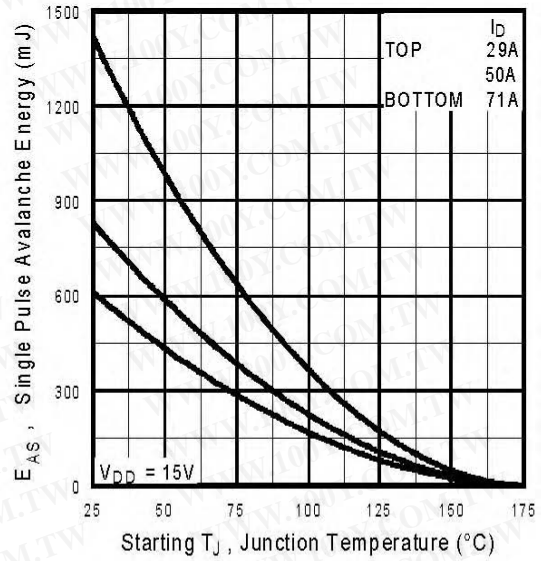
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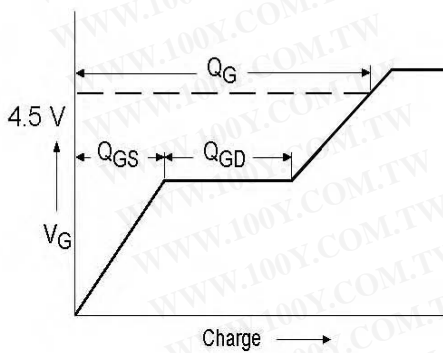
**Fig 12a.** Unclamped Inductive Test Circuit



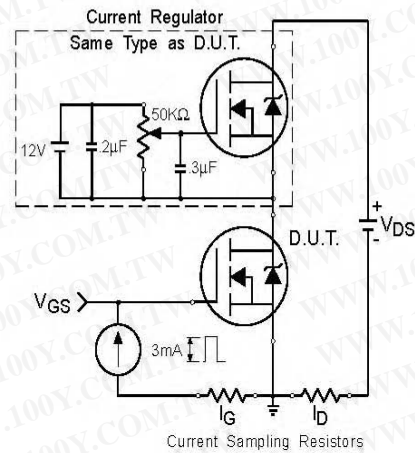
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

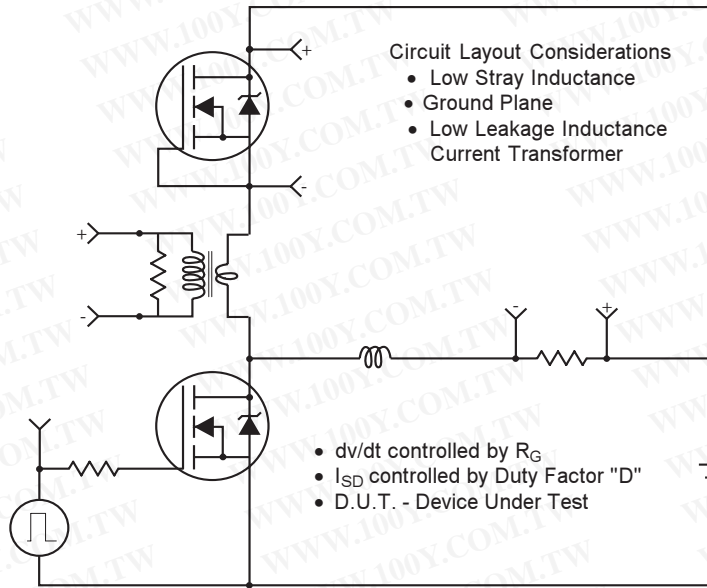


**Fig 13a.** Basic Gate Charge Waveform



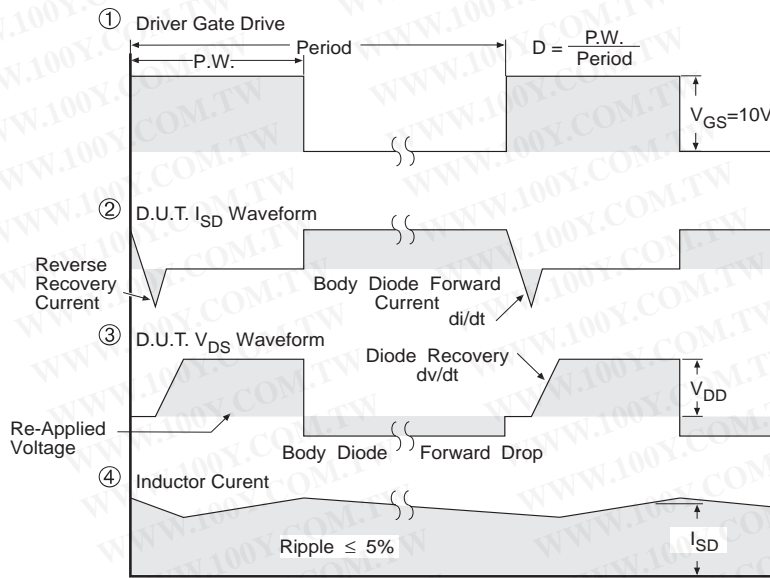
**Fig 13b.** Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity for P-Channel

\*\* Use P-Channel Driver for P-Channel Measurements



\*\*\*  $V_{GS} = 5.0V$  for Logic Level and 3V Drive Devices

Fig -14 For N Channel HEXFETS

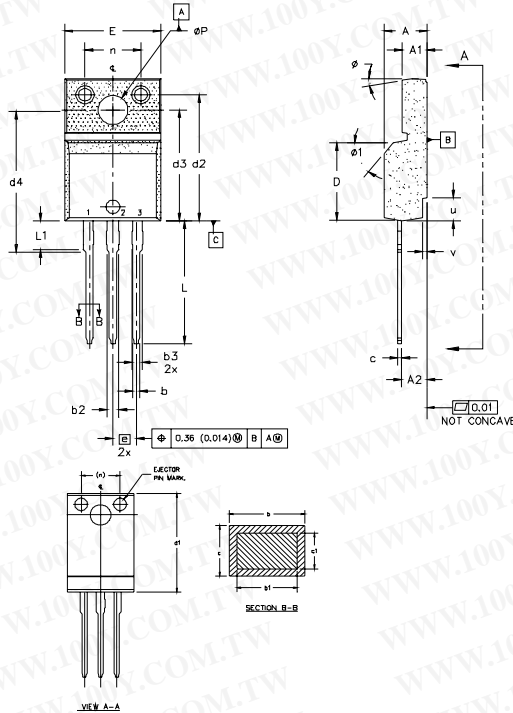
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勝特力材料 886-3-5753170  
 勝特力电子(上海) 86-21-34970699  
 勝特力电子(深圳) 86-755-83298787  
 Http://www.100y.com.tw

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## TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)



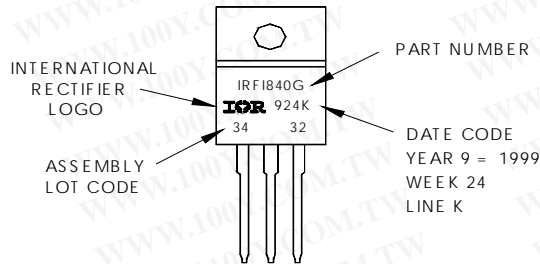
- NOTES:  
 1.0 DIMENSIONING AND TOLERANCING PER ASME Y14.5 M-1994.  
 2.0 DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).  
 3.0 LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.  
 4.0 DIMENSION D & C DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.  
 5.0 DIMENSION b1 APPLY TO BASE METAL ONLY.  
 6.0 STEP OPTIONAL ON PLASTIC BODY DEFINED BY DIMENSIONS u & v.  
 7.0 CONTROLLING DIMENSION : INCHES.

SYMBOL	DIMENSIONS				NOTES	LEAD ASSIGNMENTS
	MILLIMETERS		INCHES			
	MIN.	MAX.	MIN.	MAX.		
A	4.57	4.83	0.180	0.190		
A1	2.57	2.83	0.101	0.114		
A2	2.57	2.85	0.099	0.112		
d	0.622	0.89	0.024	0.035		
b1	0.622	0.838	0.024	0.033	5	1- GATE 2- DRAIN 3- SOURCE
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
c	0.440	0.629	0.017	0.025		
c1	0.440	0.484	0.017	0.023		
D	8.65	9.80	0.341	0.386	4	
d1	15.80	16.12	0.622	0.635		
d2	13.97	14.22	0.550	0.560		
d3	12.50	12.92	0.494	0.509		
d4	8.64	9.91	0.340	0.390		
E	10.36	10.63	0.408	0.419	4	
e	2.54 BSC		0.100 BSC			
L	13.20	13.73	0.520	0.541		
L1	3.10	3.50	0.122	0.138	3	
n	6.05	6.15	0.238	0.242		
øP	3.05	3.45	0.120	0.136		
u	2.40	2.50	0.094	0.098	6	
v	0.40	0.50	0.016	0.020	6	
e1	3"	45'	3"	45'		

## TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRF1840G  
 WITH ASSEMBLY  
 LOT CODE 3432  
 ASSEMBLED ON WW 24 1999  
 IN THE ASSEMBLY LINE "K"

**Note:** "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

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 TAC Fax: (310) 252-7903

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